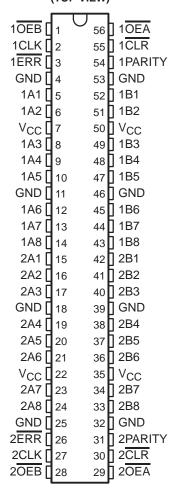
- Members of the Texas Instruments
 Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce)
 1 V at V_{CC} = 5 V, T_A = 25°C
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})
- Parity-Error Flag With Parity Generator/Checker
- Register for Storage of Parity-Error Flag
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

description

The 'ABT16833 consist of two noninverting 8-bit to 9-bit parity bus transceivers and are designed for communication between data buses. For each transceiver, when data is transmitted from the A bus to the B bus, an odd-parity bit is generated and output on the parity I/O pin (1PARITY or 2PARITY). When data is transmitted from the B bus to the A bus, 1PARITY (or 2PARITY) is configured as an input and combined with the B-input data to generate an active-low error flag if odd parity is not detected.

SN54ABT16833 . . . WD PACKAGE SN74ABT16833 . . . DGG OR DL PACKAGE (TOP VIEW)



The error (1ERR or 2ERR) output is configured as an open-collector output. The B-to-A parity-error flag is clocked into 1ERR (or 2ERR) on the low-to-high transition of the clock (1CLK or 2CLK) input. 1ERR (or 2ERR) is cleared (set high) by taking the clear (1CLR or 2CLR) input low.

The output-enable (OEA and OEB) inputs can be used to disable the device so that the buses are effectively isolated. When both OEA and OEB are low, data is transferred from the A bus to the B bus and inverted parity is generated. Inverted parity is a forced error condition that gives the designer more system diagnostic capability.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus and EPIC-IIB are trademarks of Texas Instruments Incorporated.

TEXAS INSTRUMENTS

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN54ABT16833, SN74ABT16833 DUAL 8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS097D - FEBRUARY 1991 - REVISED JANUARY 1997

description (continued)

The SN54ABT16833 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ABT16833 is characterized for operation from -40° C to 85° C.

FUNCTION TABLE

		I	NPUTS				OUTPU	JT AND I/O			
OEB	OEA	CLR	CLK	Ai Σ OF H	Bi [†] Σ OF H	Α	В	PARITY	ERR‡	FUNCTION	
L	Н	Х	Х	Odd Even	NA	NA	Α	L H	NA	A data to B bus and generate parity	
Н		Н	1	NA	Odd	В	NA	NA	Н	B data to A bus and	
L.,			'	IVA	Even		11/1	14/4	L	check parity	
Х	Χ	L	Χ	Χ	Χ	Χ	NA	NA	Н	Check error-flag register	
		Н	No↑	Χ					NC		
н	Н	L	No↑	Χ	X	7	7	_ н		2	
"	П	Н	\uparrow	Odd	^	Z Z	Z Z	۷	Z	Н	Isolation§
		Н	\uparrow	Even					L		
		Х	X	Odd	NA	NA	A	Н	NA	A data to B bus and	
	L	۸	^	Even	INA	INA	А	L	INA	generate inverted parity	

NA = not applicable, NC = no change, X = don't care

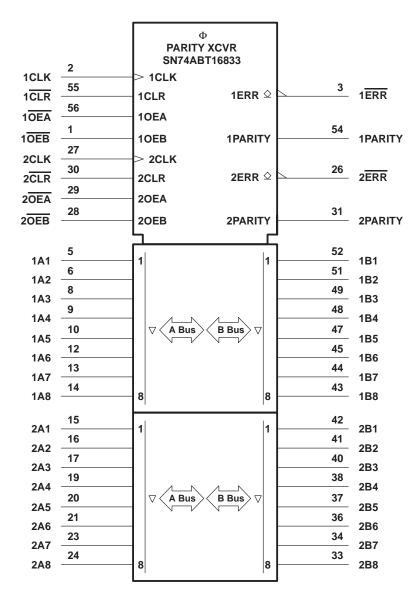


[†]Summation of high-level inputs includes PARITY along with Bi inputs.

[‡]Output states shown assume ERR was previously high.

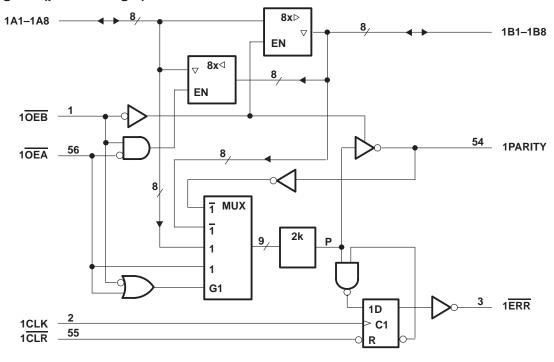
 $[\]S$ In this mode, $\overline{\mathsf{ERR}}$ (when clocked) shows inverted parity of the A bus.

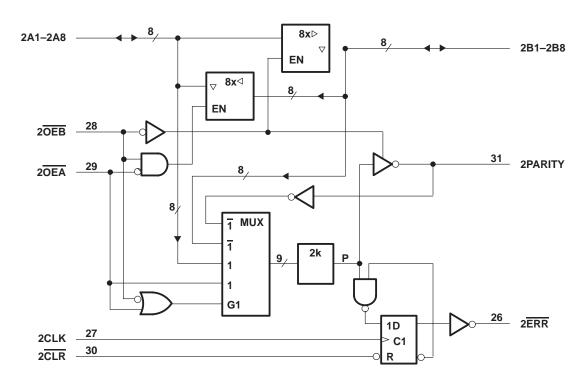
logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



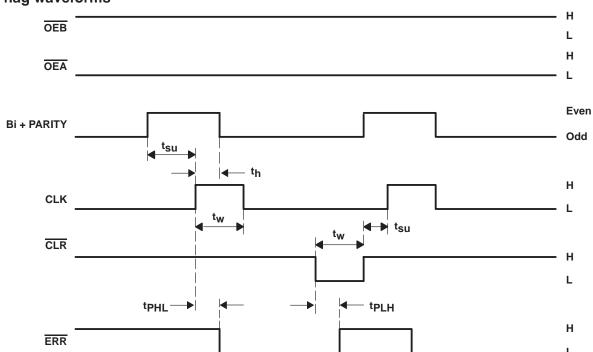


ERROR-FLAG FUNCTION TABLE

INP	UTS	INTERNAL TO DEVICE	OUTPUT PRE-STATE	OUTPUT ERR	FUNCTION		
CLR	R CLK POINT		ERR _{n-1} †	EKK			
Н	↑	Н	Н	Н			
Н	\uparrow	X	L	L	Sample		
Н	↑	L	Χ	L			
L	Χ	Х	Χ	Н	Clear		

[†] State of ERR before changes at CLR, CLK, or point P

error-flag waveforms



SN54ABT16833, SN74ABT16833 DUAL 8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS097D - FEBRUARY 1991 - REVISED JANUARY 1997

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	-0.5 V to 7 V
Input voltage range, V _I (except I/O ports) (see Note 1)	-0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, VO	. $-0.5\ V$ to $5.5\ V$
Current into any output in the low state, IO: SN54ABT16833	96 mA
SN74ABT16833	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 2): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, T _{stq}	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

			SN54AB1	16833	SN74AB1	16833	UNIT
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2	2	2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	Vcc	0	VCC	V
Vон	High-level output voltage	ERR	1	5.5		5.5	V
Іон	High-level output current	Except ERR	2	-24		-32	mA
loL	Low-level output current		20/	48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled	Q	10		10	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAI	RAMETER	TEST CON	IDITIONS	Т	A = 25°C	;	SN54AB1	Г16833	SN74AB1	16833	UNIT
PAI	RAMETER	I IEST CON	DITIONS	MIN	TYP†	MAX	MIN	MAX	MIN	MAX	UNII
VIK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2		-1.2		-1.2	V
		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5	3		2.5				
\ \ _{\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\}	All outputs	$V_{CC} = 5 V$,	$I_{OH} = -3 \text{ mA}$	3	3.4		3		3		V
VOH	except ERR	V _{CC} = 4.5 V	$I_{OH} = -24 \text{ mA}$				2				v
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*	2.7				2		
VOL		V _{CC} = 4.5 V	I _{OL} = 24 mA		0.25	0.55		0.55			V
VOL		VCC = 4.5 V	I _{OL} = 64 mA		0.3	0.55*				0.55	V
V _{hys}					100			7			mV
IOH	ERR	$V_{CC} = 4.5 \text{ V},$	V _{OH} = 5.5 V			20		20		20	μΑ
l _{off}		$V_{CC} = 0$,	V_I or $V_O \le 4.5 V$			±100		PE		±100	μΑ
ICEX	Outputs high	$V_{CC} = 5.5 \text{ V},$	$V_0 = 5.5 \text{ V}$			50	9,	50		50	μΑ
١	Control inputs	Voc - 5 5 V VI - Voc or GND				±1	35	±1		±1	μΑ
1	A or B ports	V _{CC} = 5.5 V, V _I = V	CC or GIAD			±100	90	±100		±100	μА
IJL	A or B ports	$V_{CC} = 0$,	$V_I = GND$			-50	t'a	-50		-50	μΑ
lo [‡]		$V_{CC} = 5.5 \text{ V},$	V _O = 2.5 V	-50	-100	-180	-50	-180	-50	-180	mA
I _{OZH} §		V _{CC} =5.5 V,	$V_0 = 2.7 \text{ V}$			50		50		50	μΑ
lozL§		$V_{CC} = 5.5 \text{ V},$	V _O = 0.5 V			-50		-50		-50	μΑ
		V _{CC} = 5.5 V,	Outputs high		1.5	2		2		2	
Icc	A or B ports	$I_{O} = 0$,	Outputs low		28	36		36		36	mA
		$V_I = V_{CC}$ or GND	Outputs disabled		1	2		2		2	
ΔICC¶		V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND				50		50		50	μА
Ci	Control inputs	V _I = 2.5 V or 0.5 V			3						pF
C _{io}	A or B ports	V _O = 2.5 V or 0.5 V			9						pF

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.

[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[§] The parameters $I_{\mbox{\scriptsize OZL}}$ and $I_{\mbox{\scriptsize OZL}}$ include the input leakage current.

[¶] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

SN54ABT16833, SN74ABT16833 DUAL 8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS097D - FEBRUARY 1991 - REVISED JANUARY 1997

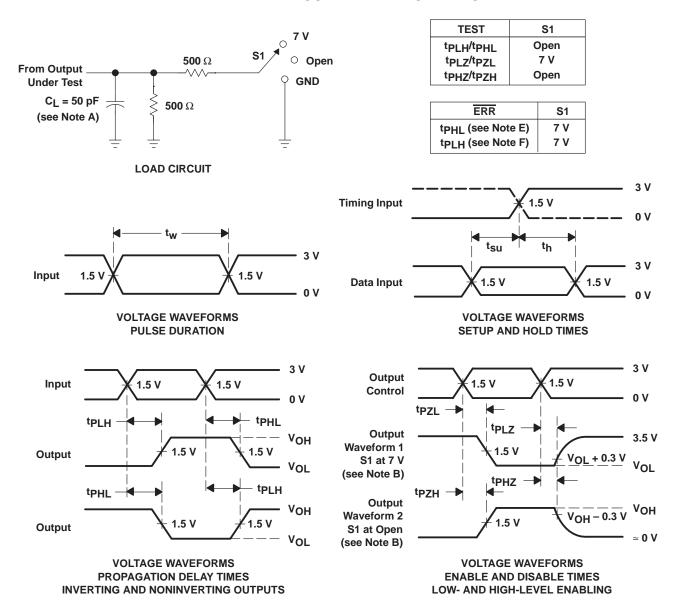
timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			V _{CC} = T _A = 2	: 5 V, 25°C	SN54AB	Г16833	SN74AB1	16833	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t _W	Pulse duration, CLK high or low		3		3,		3		ns
		A port	4.5		4.5	2	4.5		
t _{su}	Setup time before CLK↑	CLR	1		813	4	1		ns
		OEA	5		5		5		
t _h	Hold time after CLK↑	A port or OEA	0		0		0		ns

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₍	CC = 5 V 4 = 25°C	<u>',</u> ;	SN54AB	T16833	SN74ABT16833		UNIT
	(INFOT)	(001F01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
^t PLH	A or B	B or A	1.5	2.5	3.3	1.5	4.2	1.5	4.1	ns
^t PHL	AUIB	D 31 A	2	3.1	3.9	2	4.5	2	4.3	115
^t PZH	ŌĒ	A or B	2	3.9	4.9	2	5.8	2	5.6	ns
^t PZL	OE	AOID	2.5	4.3	5.1	2.5	6.2	2.5	6	115
^t PHZ	<u></u>	A or B	2	3.6	4.5	2	5.5	2	5.4	ns
tPLZ	ŌĒ		1.5	3	3.8	1.5	4.7	1.5	4.3	113
^t PLH	. =	PARITY	2	4.6	5.4	2/	. 7	2	6.7	ns
^t PHL	A or OE	FANITI	2	4.3	5.1	2	6.5	2	6.1	115
^t PZH	ŌĒ	PARITY	2	3.6	5	0 2	5.8	2	5.7	ns
^t PZL	OE	FARITI	2.5	4.4	5.8	2.5	6.7	2.5	6.5	115
^t PHZ		DADITY	1.5	3.2	4	1.5	4.8	1.5	4.7	20
tPLZ	ŌĒ	PARITY	1.5	2.9	3.7	1.5	4.2	1.5	4.1	ns
t _{PLH}	CLK, CLR	ERR	2	3.4	4.2	2	4.8	2	4.6	ns
tPHL	CLK		2	2.8	3.6	2	4.1	2	3.9	115

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpHL is measured at 1.5 V.
- F. tpLH is measured at VOL + 0.3 V.

Figure 1. Load Circuit and Voltage Waveforms



www.ti.com 14-Oct-2022

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ABT16833DL	ACTIVE	SSOP	DL	56	20	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16833	Samples
SN74ABT16833DLR	ACTIVE	SSOP	DL	56	1000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ABT16833	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



PACKAGE OPTION ADDENDUM

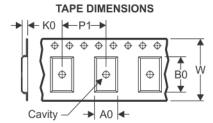
www.ti.com 14-Oct-2022

PACKAGE MATERIALS INFORMATION

www.ti.com 5-Jan-2022

TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

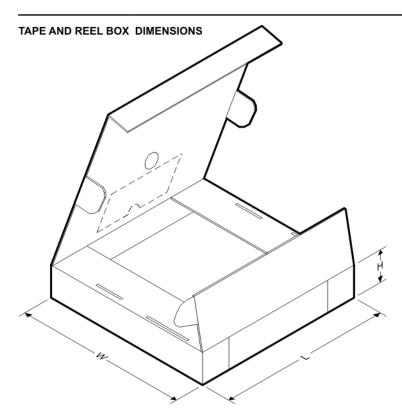
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ABT16833DLR	SSOP	DL	56	1000	330.0	32.4	11.35	18.67	3.1	16.0	32.0	Q1

www.ti.com 5-Jan-2022



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ABT16833DLR	SSOP	DL	56	1000	367.0	367.0	55.0

PACKAGE MATERIALS INFORMATION

www.ti.com 5-Jan-2022

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74ABT16833DL	DL	SSOP	56	20	473.7	14.24	5110	7.87

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2022, Texas Instruments Incorporated